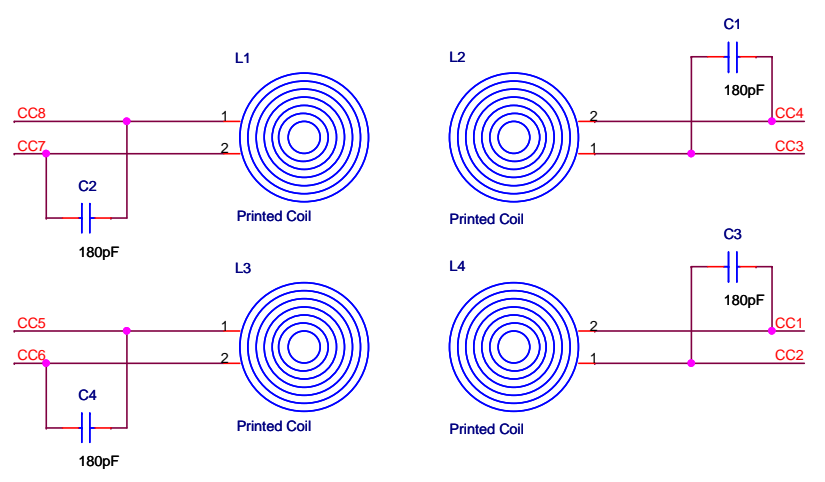
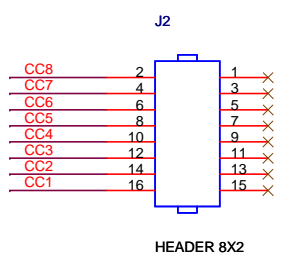
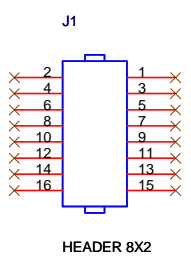
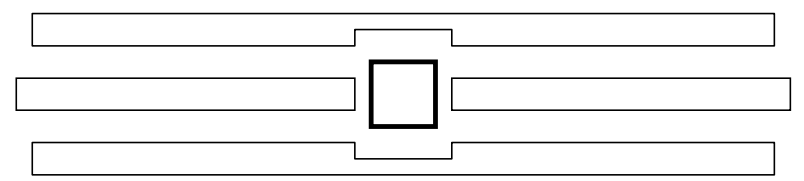
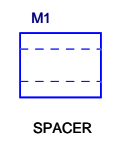


PCB Assembly Stack



- M6 Washer 0.25 x 0.126 x 0.01
- M7 Washer 0.25 x 0.126 x 0.01
- M8 Washer 0.25 x 0.126 x 0.01
- M9 Washer 0.25 x 0.126 x 0.01
- M10 Washer 0.25 x 0.126 x 0.01



- M11 M3X8 Stainless Steel Hex Standoff, 10mm, 100 piece
- M12 M3X8 Stainless Steel Hex Standoff, 10mm, 100 piece
- M13 M3X8 Stainless Steel Hex Standoff, 10mm, 100 piece
- M14 M3X8 Stainless Steel Hex Standoff, 10mm, 100 piece
- M15 M3 Hex Flat, 100 piece
- M16 M3 Hex Flat, 100 piece
- M17 M3 Hex Flat, 100 piece
- M18 M3 Hex Flat, 100 piece

Title		1-Degree Dial Coil Board	
Size	Document Number	TIDA-00508 LDC 1-Degree Dial -Coil	
Date:	Thursday, February 19, 2015	Sheet	1 of 1
		Rev	1

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